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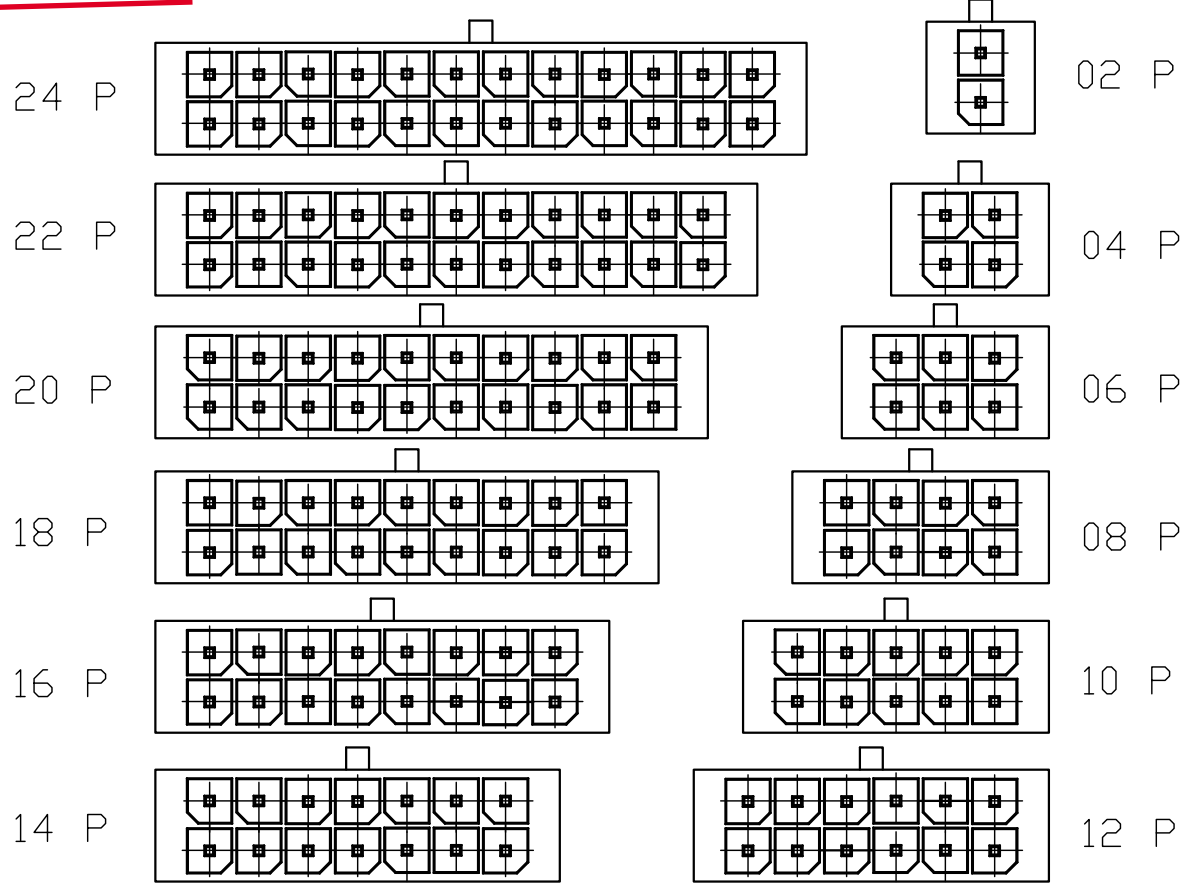
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REVISIONS				
SYM	ECN No.	DESCRIPTION	DATE	APPROVED
A		RELEASE FOR RoHS	10/06/2005	Henry Ko
B	NE-11044	DRAWING UPDATE	03/28/2011	Arron Lin
C	NE-12011	ADDED DIM. 4.6 & 0.93	02/10/2012	Arron Lin
D	NE-13023	ADDED 30u" GOLD	01/31/2013	Arron Lin
EX1		ADDED DIM	07/22/2013	Arron Lin
EX2	EDSR#4667	ADDED 2PIN DRAWING AND UPDATE PACKING QUANTITY	01/08/2014	Arron Lin
EX3		UPDATE PACKING QUANTITY	03/03/2014	Arron Lin

02~24 PIN TOP VIEW

**PRELIMINARY RELEASE
SUBJECT TO CHANGE**



TOLERANCE		APPROVALS		DATE	TITLE		Amphenol® Amphenol Corporation Amphenol Taiwan Corporation			
X.		DRAWN	Debby Hung	03/03/2014	G881A SERIES WIRE TO BOARD, WAFER 3.00 MM PITCH R/A PCB MOUNT		PART No. G881AXX0X1TEU			
X.X	±0.30	CHECKED	Roger Tsai	03/03/2014						
X.XX	±0.20	APPROVED	Arron Lin	03/03/2014			SCALE		REV. EX3	
X.XXX	±0.10	DWG TYPE	CUST DWG	PROJECT CODE			PHD	UNIT	mm	SIZE
ANGULAR	±1°	UNLESS OTHERWISE SPECIFIED					SCALE	NA	SHEET	2 OF 3
							DWG No.		G881AXX0X1TEU	

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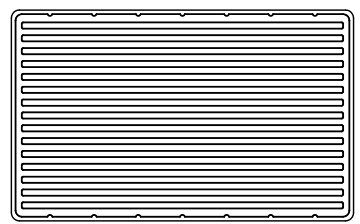
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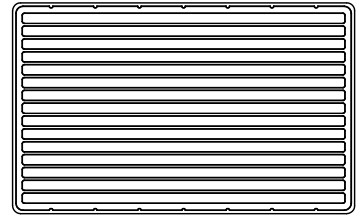
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426(L)*262.5(W)*10(H)

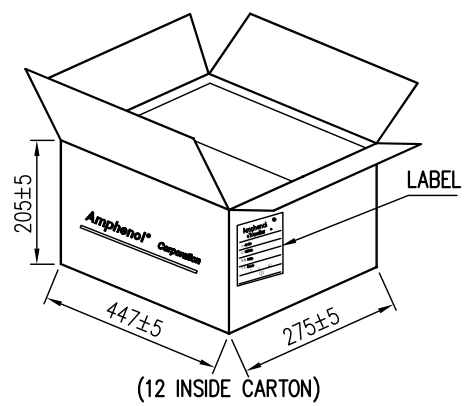
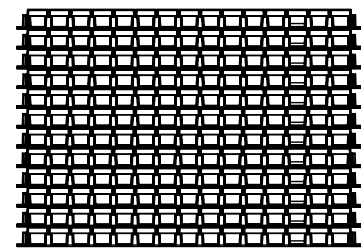
426(L)*262.5(W)*14(H)



TRAY BOTTOM COVER



TRAY TOP COVER



POS	PCS/TRAY	PCS/CARTON
02	900	10800
04	615	7380
06	465	5580
08	375	4500
10	315	3780
12	270	3240
14	240	2880
16	210	2520
18	180	2160
20	165	1980
22	150	1800
24	150	1800

- NOTE:
- MATERIAL : BLACK CONDUCTIVE POLYSTYRENE ALLOY
 - ALL DIMENSIONS MEET EIA-481-C REQUIREMENTS.
 - THICKNESS : 0.80±0.05mm.

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X.XXX	±0.10	DWG TYPE CUST DWG		PROJECT CODE PHD			SCALE NA	SHEET 3 OF 3	